

RoHS Compliant

成品图

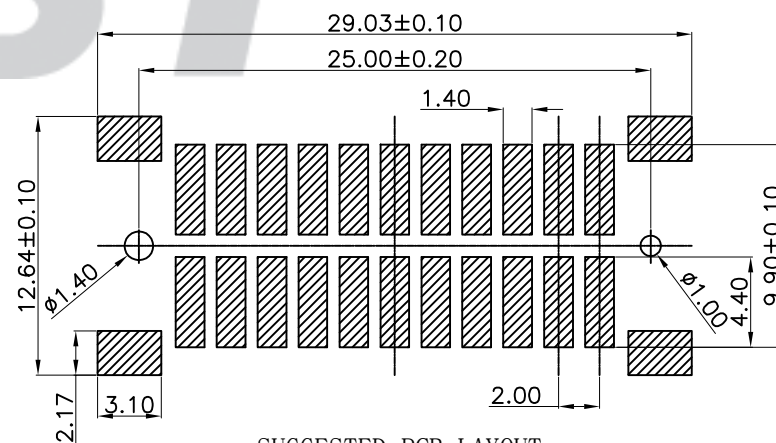
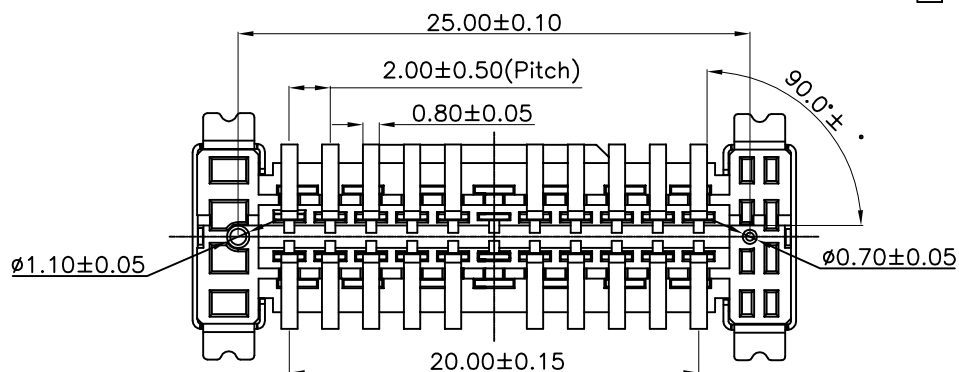
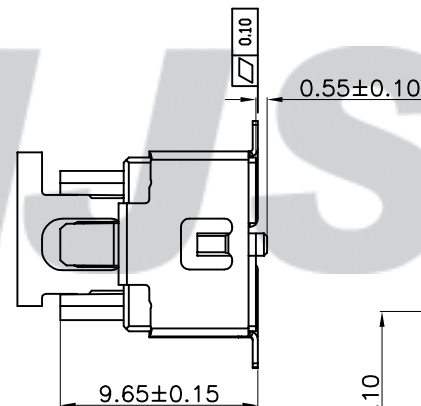
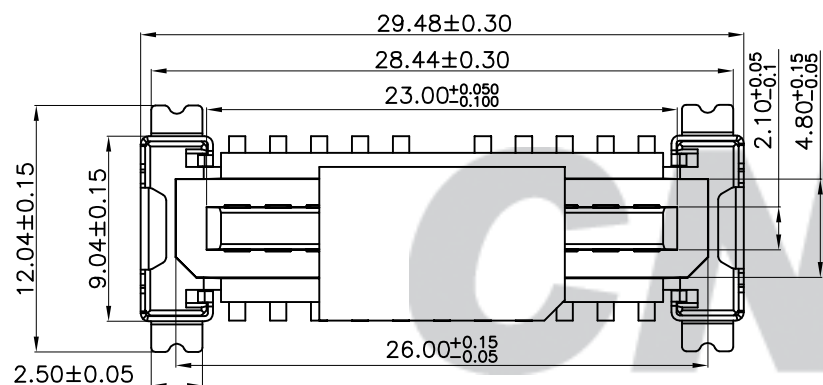
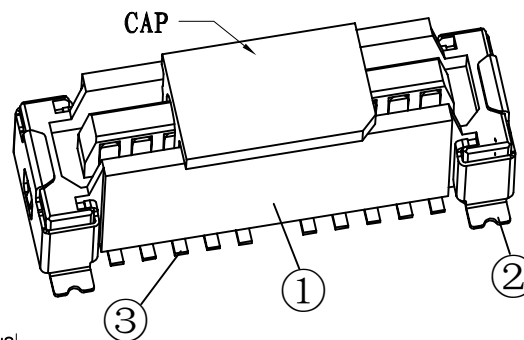
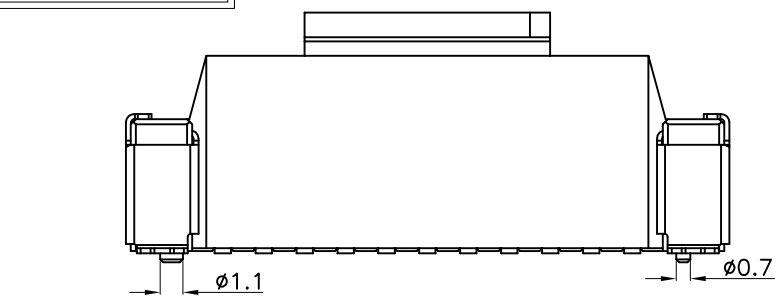
SPECIFICATION

- 1 Contact resistance:  $\leq 100m\Omega$
- 2 Insulation resistance:  $\geq 50M\Omega$
- 3 Rated voltage: 100 V AC DC
- 4 Rated current: 1.0 A AC DC
- 5 Withstand Voltage: 250V AC/minute
- 6 Temperature Range:  $-40^{\circ}C \sim +85^{\circ}C$

ORDER INFORMATION:

**B2004G-211P20-F2ME-R**

PART No. \_\_\_\_\_ PACKAGING: R=REEL  
 No. OF CIRCUITS: \_\_\_\_\_ PLATING: E=Sn+Gold  
 2\*11  
 PLASTIC MATERIAL: \_\_\_\_\_  
 F2M=LCP (NATURE)



SUGGESTED PCB LAYOUT  
(COMPONENT SIDE)

专利产品

B/0	2016.04.12	NEW RELEASE	
REV.	DATE	DESCRIPTION	APPD.

③	Solder Tab	2	Brass	Mattn Sn
②	Contacts	20	Phosphor Bronze	Mattn Sn/Gold-plated
①	Insulator	1	LCP	Nature
NO.	DESCRIPTION	QTY	MATERIAL	PLATING/COLOR

Tolerance	Model Name: 2.00mm pitch 180° WAFER-SMT TYPE
X.X ±0.30	Model No: B2004G-211P20-F2ME-R
X.XX ±0.20	
X.XXX ±0.10	
Angle ±3.0°	
UNIT: mm	

Drawn: 张育斌 2016.05.03
Checked: 林旭芝
Approved: 刘祚杰
DWG NO. CNJST/GCCP-0398

SCALE: FULL REVISION: B/0  
**CNJST** 浙江捷仕泰电子有限公司  
 ZHEJIANG JIESHITAI ELECTRONICS CO., LTD.